

IoT Semiconductor - Market Share Analysis, Industry Trends & Statistics, Growth Forecasts (2025 - 2030)

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Report description:

IoT Semiconductor Market Analysis

The IoT Semiconductor Market size is estimated at USD 0.67 trillion in 2025, and is expected to reach USD 1.32 trillion by 2030, at a CAGR of 14.70% during the forecast period (2025-2030). The Global IoT Semiconductor market size expansion is powered by distributed edge-AI processing, industrial automation programs, and a steady rise in connected consumer devices. Manufacturers are moving workloads from cloud to edge, forcing IoT silicon to add neural acceleration while holding power budgets below single-digit milliwatts. Government incentives aimed at regionalizing semiconductor fabrication are encouraging new fabs in North America and Europe, while reshoring policies are altering sourcing strategies across the Global IoT Semiconductor market. Supply-chain diversification aligns with technology-node bifurcation: advanced nodes (<14 nm) enable resource-intensive AI inference, whereas mature nodes (40-28 nm) keep costs competitive for mass-market sensors.

Global IoT Semiconductor Market Trends and Insights

Proliferation of Connected Consumer and Wearable Devices

Demand for ambient computing experiences is lifting volumes for ultra-low-power chips that keep sensors and radios active at all times. Health-focused wearables now integrate medical-grade photoplethysmography, temperature, and ECG sensors that need secure data paths to comply with tightening privacy rules. Qualcomm reported USD 1.5 billion in IoT revenue for Q1 2025, up 36% year over year, underscoring consumer momentum. As 5G modems converge with on-device AI, designers shift to heterogeneous

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SoCs that fuse application processors, NPUs, and connectivity on one die, driving silicon-area efficiency across the Global IoT Semiconductor market.

Industry 4.0-Led Demand for Low-Power MCUs

Factories deploying digital twins and predictive maintenance lean on microcontrollers that ingest vibration, thermal, and acoustic data locally, cutting network latency. Intel's smart-factory line achieved near-theoretical yield through real-time lithography calibration, proving the value of edge analytics inside harsh environments. Rugged MCUs now combine machine-learning instruction sets with secure boot and OTA updates, positioning the Global IoT Semiconductor market for sustained industrial orders through the decade.

End-to-End Security and Privacy Vulnerabilities

The White House Cyber Trust Mark requires compliance with NIST IR 8425, raising the bar for secure-element integration in resource-limited devices. Cost-sensitive OEMs face additional silicon area and firmware validation expenses. Rising quantum-computing threats press chipmakers to support lattice-based cryptography, delaying product launches and tempering short-term Global IoT Semiconductor market growth.

Other drivers and restraints analyzed in the detailed report include:

Automotive ADAS and V2X Silicon Requirements / Edge-AI Inference Inside IoT SoCs / Legacy-Node (28/40 nm) Foundry Capacity Crunch /

For complete list of drivers and restraints, kindly check the Table Of Contents.

Segment Analysis

Processors generated the largest revenue slice in 2024 at 25.65%, anchored by single-die combos that merge CPU, NPU, and multi-protocol radios. Enhanced integration trims printed-circuit area and shortens certification cycles, fortifying processor dominance in the Global IoT Semiconductor market. Security ICs are poised for the fastest expansion with a 17.90% CAGR as zero-trust architectures embed hardware roots-of-trust into every node of the IoT Semiconductor market. Sensor, connectivity, memory, logic, and power-management lines track broader unit shipment curves, with specialized low-power DRAM commanding premium price points.

Upgrades in in-package voltage regulation now supply sub-0.5 V rails for AI accelerators, extending battery life in wearables. MEMS makers push shippable pressure sensors below 0.8 mm height, opening design space in rings and earbuds. SEALSQ secured contracts for 24 million quantum-resistant chips that protect UK smart meters, showcasing a security shift across critical infrastructure.

Industrial and manufacturing retained a 22.71% share in 2024 as digital-twin rollouts scaled across APAC plants. Demand for condition-monitoring MCUs sustains double-digit unit growth through 2030. Automotive leads in CAGR at 16.74% as software-defined vehicles centralize compute domains. The IoT Semiconductor market size for automotive silicon is projected to climb sharply on the back of zonal architectures that cut harness weight and enable OTA feature upsells.

Healthcare extends beyond remote monitoring to regulated device connectivity frameworks, strengthening demand for certified secure elements. Retail pilots using AI-powered inventory robots enlist vision-optimized SoCs to reconcile shelf stock in real time, diversifying the IoT Semiconductor market revenue base. Building-automation orders rise as passive optical networks connect

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HVAC, lighting, and security over a single fibre backbone.

The IoT Semiconductor Market is Segmented by Product (Processor, Sensor, and More), End-User (Healthcare, Consumer Electronics, and More), Technology Node, Connectivity Technology (Bluetooth/BLE, Wi-Fi, and More), Processor Architecture (Arm-Based, RISC-V, and More), and Geography. The Market Forecasts are Provided in Terms of Value (USD).

Geography Analysis

Asia-Pacific contributed 34.92% of the IoT Semiconductor market revenue in 2024, propelled by Taiwan's 63.8% share of total semiconductor output and China's capacity build-out. Vertical integration from wafer to packaging lowers lead times, letting OEMs iterate faster. Yet export controls nudge multinational OEMs toward capacity hedging in Japan, India, and the United States, reshaping the IoT Semiconductor market supply map.

The Middle East and Africa exhibit the fastest trajectory at 18.71% CAGR. Gulf smart-city budgets allocate billions for traffic analytics, energy dashboards, and public-safety sensor grids, demanding robust, wide-temperature-range silicon. 5G rollouts across North Africa unlock low-latency telemetry for logistics corridors stretching from ports to inland free-trade zones, enlarging the endpoint base for the IoT Semiconductor market.

North America and Europe remain innovation centers. The U.S. CHIPS Act channels USD 50 billion into fabs across 16 states, doubling domestic advanced-node capacity to 22% by 2027. Europe's Chips Act targets a 20% global share by 2030, with Intel and STMicroelectronics investing in Germany and France clusters. These regions prioritize high-value automotive and medical silicon, forming lucrative slices of the IoT Semiconductor market size despite moderate unit growth.

List of Companies Covered in this Report:

Qualcomm Technologies Inc. / Intel Corporation / Texas Instruments Incorporated / NXP Semiconductors N.V. / Cypress Semiconductor Corporation (Infineon) / MediaTek Inc. / Microchip Technology Inc. / Samsung Electronics Co., Ltd. / Silicon Laboratories Inc. / TDK InvenSense Inc. / STMicroelectronics N.V. / Nordic Semiconductor ASA / Analog Devices, Inc. / Broadcom Inc. / Infineon Technologies AG / Renesas Electronics Corporation / ON Semiconductor Corporation / Arm Holdings plc / NVIDIA Corporation / Marvell Technology Group Ltd. /

Additional Benefits:

The market estimate (ME) sheet in Excel format /
3 months of analyst support /

Table of Contents:

1 INTRODUCTION

1.1 Study Assumptions and Market Definition

1.2 Scope of the Study

2 RESEARCH METHODOLOGY

3 EXECUTIVE SUMMARY

4 MARKET LANDSCAPE

4.1 Market Overview

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- 4.2 Market Drivers
 - 4.2.1 Proliferation of connected consumer and wearable devices
 - 4.2.2 Industry 4.0-led demand for low-power MCUs
 - 4.2.3 Automotive ADAS and V2X silicon requirements
 - 4.2.4 Edge-AI inference inside IoT SoCs
 - 4.2.5 Matter protocol accelerating smart-home refresh cycles
 - 4.2.6 Satellite and sub-GHz connectivity for remote asset tracking
- 4.3 Market Restraints
 - 4.3.1 End-to-end security and privacy vulnerabilities
 - 4.3.2 Fragmented communications standards
 - 4.3.3 Legacy-node (28/40 nm) foundry capacity crunch
 - 4.3.4 Export-control limits on advanced RF IP
- 4.4 Industry Value Chain Analysis
- 4.5 Regulatory Landscape
- 4.6 Technological Outlook
- 4.7 Porter's Five Forces Analysis
 - 4.7.1 Bargaining Power of Suppliers
 - 4.7.2 Bargaining Power of Buyers
 - 4.7.3 Threat of New Entrants
 - 4.7.4 Threat of Substitute Products
 - 4.7.5 Intensity of Competitive Rivalry
- 4.8 Impact of Macroeconomic Trends on the Market

5 MARKET SIZE AND GROWTH FORECASTS (VALUES)

- 5.1 By Product
 - 5.1.1 Processor
 - 5.1.2 Sensor
 - 5.1.3 Connectivity IC
 - 5.1.4 Memory Device
 - 5.1.5 Logic Device
 - 5.1.6 Power-Management IC
 - 5.1.7 Security IC
- 5.2 By End-user
 - 5.2.1 Healthcare
 - 5.2.2 Consumer Electronics
 - 5.2.3 Industrial and Manufacturing
 - 5.2.4 Automotive
 - 5.2.5 BFSI
 - 5.2.6 Retail
 - 5.2.7 Building Automation
 - 5.2.8 Other End-users
- 5.3 By Technology Node
 - 5.3.1 >90 nm
 - 5.3.2 65-45 nm
 - 5.3.3 40-28 nm
 - 5.3.4 22-16 nm
 - 5.3.5 <14 nm

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- 5.4 By Connectivity Technology
 - 5.4.1 Bluetooth / BLE
 - 5.4.2 Wi-Fi (802.11x)
 - 5.4.3 NB-IoT / LTE-M
 - 5.4.4 5G RedCap
 - 5.4.5 Ultra-Wideband (UWB)
 - 5.4.6 Thread / Zigbee
 - 5.4.7 Satellite IoT
- 5.5 By Processor Architecture
 - 5.5.1 Arm-based
 - 5.5.2 RISC-V
 - 5.5.3 x86
 - 5.5.4 Other / Hybrid
- 5.6 By Geography
 - 5.6.1 North America
 - 5.6.1.1 United States
 - 5.6.1.2 Canada
 - 5.6.1.3 Mexico
 - 5.6.2 South America
 - 5.6.2.1 Brazil
 - 5.6.2.2 Argentina
 - 5.6.2.3 Rest of South America
 - 5.6.3 Europe
 - 5.6.3.1 Germany
 - 5.6.3.2 United Kingdom
 - 5.6.3.3 France
 - 5.6.3.4 Italy
 - 5.6.3.5 Spain
 - 5.6.3.6 Rest of Europe
 - 5.6.4 Asia-Pacific
 - 5.6.4.1 China
 - 5.6.4.2 Japan
 - 5.6.4.3 South Korea
 - 5.6.4.4 India
 - 5.6.4.5 Singapore
 - 5.6.4.6 Australia
 - 5.6.4.7 Rest of Asia-Pacific
 - 5.6.5 Middle East and Africa
 - 5.6.5.1 Middle East
 - 5.6.5.1.1 Saudi Arabia
 - 5.6.5.1.2 United Arab Emirates
 - 5.6.5.1.3 Turkey
 - 5.6.5.1.4 Rest of Middle East
 - 5.6.5.2 Africa
 - 5.6.5.2.1 South Africa
 - 5.6.5.2.2 Nigeria
 - 5.6.5.2.3 Egypt

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5.6.5.2.4 Rest of Africa

6 COMPETITIVE LANDSCAPE

6.1 Market Concentration

6.2 Strategic Moves

6.3 Market Share Analysis

6.4 Company Profiles (includes Global level Overview, Market level overview, Core Segments, Financials as available, Strategic Information, Market Rank/Share, Products and Services, Recent Developments)

6.4.1 Qualcomm Technologies Inc.

6.4.2 Intel Corporation

6.4.3 Texas Instruments Incorporated

6.4.4 NXP Semiconductors N.V.

6.4.5 Cypress Semiconductor Corporation (Infineon)

6.4.6 MediaTek Inc.

6.4.7 Microchip Technology Inc.

6.4.8 Samsung Electronics Co., Ltd.

6.4.9 Silicon Laboratories Inc.

6.4.10 TDK InvenSense Inc.

6.4.11 STMicroelectronics N.V.

6.4.12 Nordic Semiconductor ASA

6.4.13 Analog Devices, Inc.

6.4.14 Broadcom Inc.

6.4.15 Infineon Technologies AG

6.4.16 Renesas Electronics Corporation

6.4.17 ON Semiconductor Corporation

6.4.18 Arm Holdings plc

6.4.19 NVIDIA Corporation

6.4.20 Marvell Technology Group Ltd.

7 MARKET OPPORTUNITIES AND FUTURE OUTLOOK

7.1 White-space and Unmet-Need Assessment

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